

PHOTOCOUPLER

PS2805A-1,PS2805A-4

HIGH ISOLATION VOLTAGE AC INPUT RESPONSE TYPE SSOP PHOTOCOUPLER

-NEPOC Series-

DESCRIPTION

The PS2805A-1 and PS2805A-4 are optically coupled isolators containing a GaAs light emitting diode and an NPN silicon phototransistor in a plastic SSOP for high density applications to realize an excellent cost performance.

This package has shield effect to cut off ambient light.

FEATURES

- · Lead-free product: Solder plating specification Sn-Bi
- High isolation voltage (BV = 2 500 Vr.m.s.)
- Small and thin package (4, 16-pin SSOP, Pin pitch 1.27 mm)
- AC input response
- Ordering number of tape product: PS2805A-1-F3, F4, PS2805A-4-F3, F4
- Safety standards
 - UL approved: File No. E72422
 - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

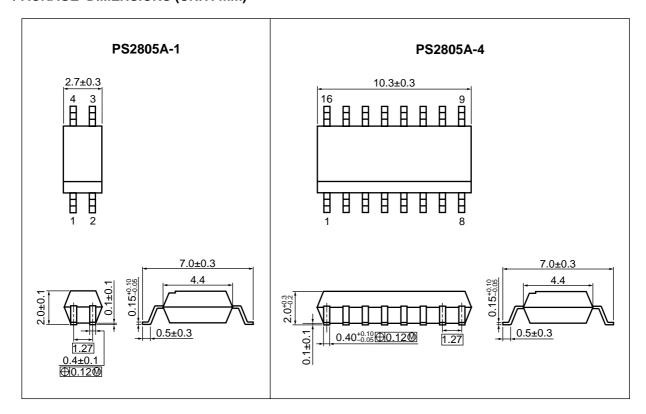
APPLICATIONS

- · Programmable logic controllers
- OA equipment
- · Measuring instruments
- Hybrid IC

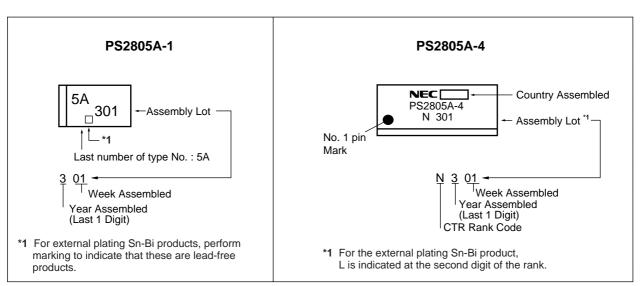
PIN CONNECTION (Top View) PS2805A-1 1. Anode, Cathode 2. Cathode, Anode 3. Emitter 4. Collector PS2805A-4 16151413121110 9 PS2805A-4 16151413121110 9 PS2805A-5 1. 3. 5. 7. Anode, Cathode 2. 4. 6. 8. Cathode, Anode 9. 11. 13. 15. Emitter 10. 12. 14. 16. Collector

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PACKAGE DIMENSIONS (UNIT: mm)



MARKING EXAMPLE





ORDERING INFORMATION

Part Number	Package	Packing Style	Safety Standards Approval	Solder Plating Specification	Application Part Number*1
PS2805A-1	4-pin SSOP	50 pcs (Tape 50 pcs cut)	Standard products	Sn-Pb	PS2805A-1
PS2805A-1-F3		Embossed Tape 3 500 pcs/reel	(UL approved)		
PS2805A-1-F4					
PS2805A-4	16-pin SSOP	Magazine Case 45 pcs			PS2805A-4
PS2805A-4-F3		Embossed Tape 2 500 pcs/reel			
PS2805A-4-F4					
PS2805A-1-V	4-pin SSOP	50 pcs (Tape 50 pcs cut)	DIN EN60747-5-2		PS2805A-1
PS2805A-1-V-F3		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)		
PS2805A-1-V-F4			Approved (Option)		
PS2805A-4-V	16-pin SSOP	Magazine Case 45 pcs			PS2805A-4
PS2805A-4-V-F3		Embossed Tape 2 500 pcs/reel			
PS2805A-4-V-F4					
PS2805A-1-A	4-pin SSOP	50 pcs (Tape 50 pcs cut)	Standard products	Sn-Bi	PS2805A-1
PS2805A-1-F3-A		Embossed Tape 3 500 pcs/reel	(UL approved)		
PS2805A-1-F4-A					
PS2805A-4-A	16-pin SSOP	Magazine Case 45 pcs			PS2805A-4
PS2805A-4-F3-A		Embossed Tape 2 500 pcs/reel			
PS2805A-4-F4-A					
PS2805A-1-V-A	4-pin SSOP	50 pcs (Tape 50 pcs cut)	DIN EN60747-5-2		PS2805A-1
PS2805A-1-V-F3-A		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)		
PS2805A-1-V-F4-A			Approved (Option)		
PS2805A-4-V-A	16-pin SSOP	Magazine Case 45 pcs			PS2805A-4
PS2805A-4-V-F3-A		Embossed Tape 2 500 pcs/reel			
PS2805A-4-V-F4-A					

^{*1} For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings		Unit
			PS2805A-1	PS2805A-4	
Diode	Forward Current (DC)	lF	±30		mA
	Power Dissipation Derating	⊿P _D /°C	0.6	0.8	mW/°C
	Power Dissipation	P□	60	80	mW/ch
	Peak Forward Current [™]	IFP	±C	±0.5	
Transistor	Collector to Emitter Voltage	Vceo	70		V
	Emitter to Collector Voltage	Veco	ţ	5	V
	Collector Current	lc 30		0	mA/ch
	Power Dissipation Derating	⊿Pc/°C	1	.2	mW/°C
	Power Dissipation	Pc	12	20	mW/ch
Isolation Voltage *2		BV	2 500		Vr.m.s.
Operating Ambient Temperature		TA	-55 to +100		°C
Storage Temperature		T _{stg}	-55 to +150		°C

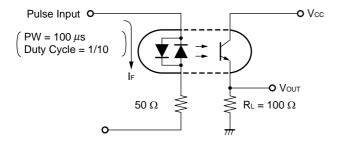
^{*1} PW = 100 μ s, Duty Cycle = 1 %

^{*2} AC voltage for 1 minute at T_A = 25 °C, RH = 60 % between input and output

ELECTRICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

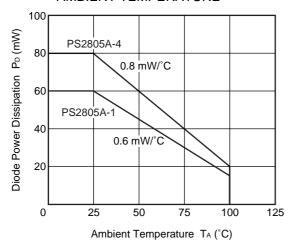
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	$I_F = \pm 5 \text{ mA}$		1.2	1.4	V
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		20		pF
Transistor	Collector to Emitter Dark Current	ICEO	Vce = 70 V, I _F = 0 mA			100	nA
Coupled	Current Transfer Ratio (Ic/IF)	CTR	$I_F = \pm 5 \text{ mA}, V_{CE} = 5 \text{ V}$	50		400	%
	Collector Saturation Voltage	V _{CE(sat)}	I _F = 10 mA, I _C = 2 mA		0.13	0.3	V
	Isolation Resistance	R _{I-O}	Vi-o = 1.0 kVpc	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1.0 MHz		0.4		pF
	Rise Time *1	Tr	$Vcc = 5 \text{ V}, \text{ Ic} = 2 \text{ mA}, \text{ RL} = 100 \Omega$		5		μs
	Fall Time *1	t _f			7		

*1 Test circuit for switching time

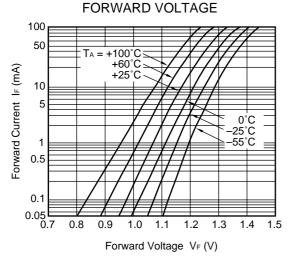


TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

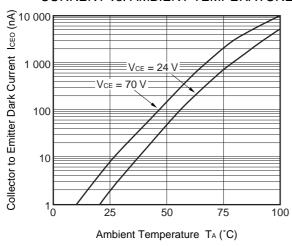
DIODE POWER DISSIPATION vs. AMBIENT TEMPERATURE



FORWARD CURRENT vs.

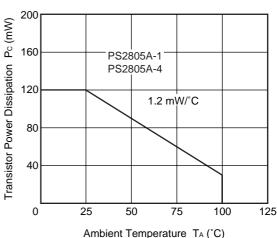


COLLECTOR TO EMITTER DARK **CURRENT vs. AMBIENT TEMPERATURE**

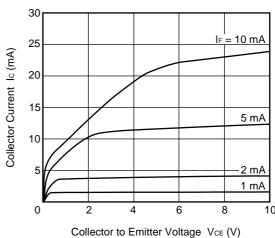


Remark The graphs indicate nominal characteristics.

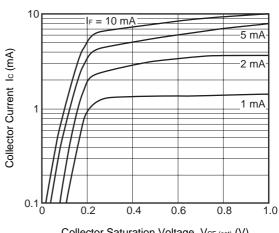
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



COLLECTOR CURRENT vs. **COLLECTOR TO EMITTER VOLTAGE**

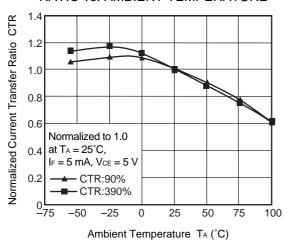


COLLECTOR CURRENT vs. **COLLECTOR SATURATION VOLTAGE**

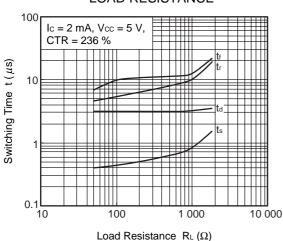


Collector Saturation Voltage VCE (sat) (V)

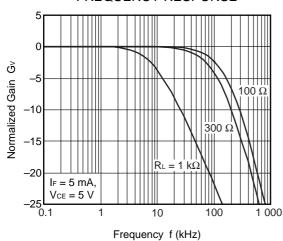
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



SWITCHING TIME vs. LOAD RESISTANCE

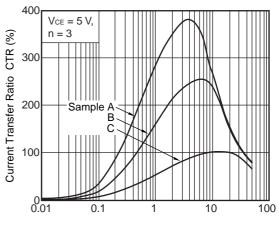


FREQUENCY RESPONSE



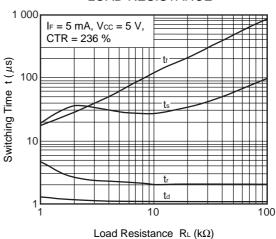
Remark The graphs indicate nominal characteristics.

CURRENT TRANSFER RATIO vs. FORWARD CURRENT

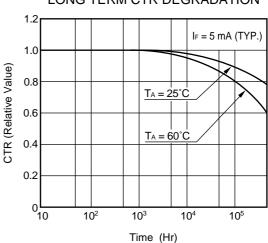


Forward Current IF (mA)

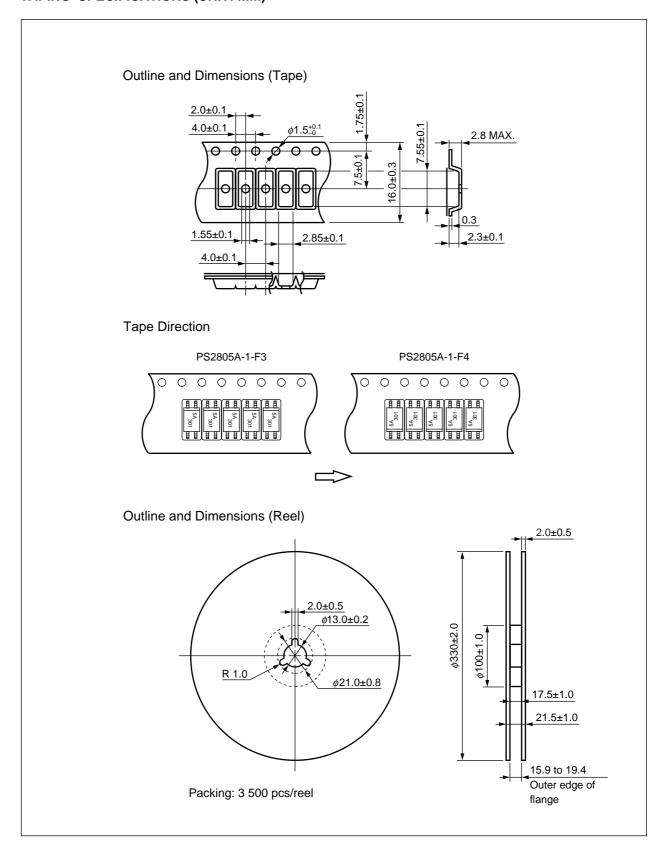
SWITCHING TIME vs. LOAD RESISTANCE

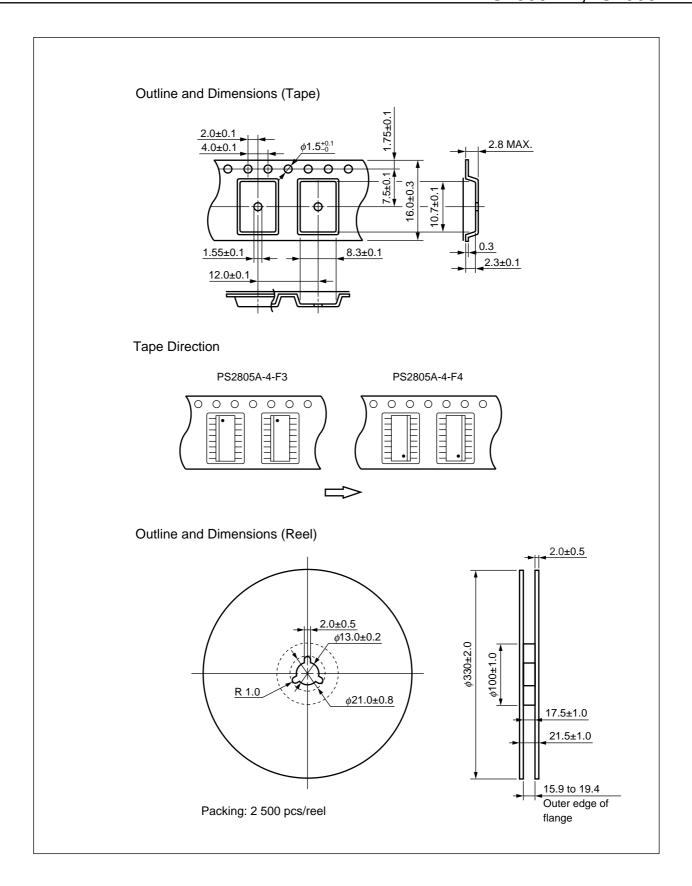


LONG TERM CTR DEGRADATION



TAPING SPECIFICATIONS (UNIT: mm)





NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

Peak reflow temperature
 260°C or below (package surface temperature)

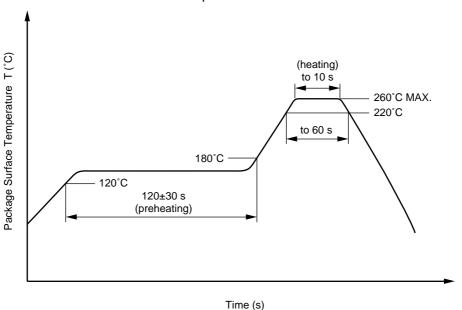
Time of peak reflow temperature
 Time of temperature higher than 220°C
 60 seconds or less

Time to preheat temperature from 120 to 180°C 120±30 s
 Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

Preheating conditions 120°C or below (package surface temperature)

Number of times
 One (Allowed to be dipped in solder including plastic mold portion.)

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

Peak Temperature (lead part temperature) 350°C or below
 Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(b) Please be sure that the temperature of the package would not be heated over 100°C

(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output side may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- **2.** Avoid storage at a high temperature and high humidity.

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M8E 00.4-0110

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

▶ For further information, please contact

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